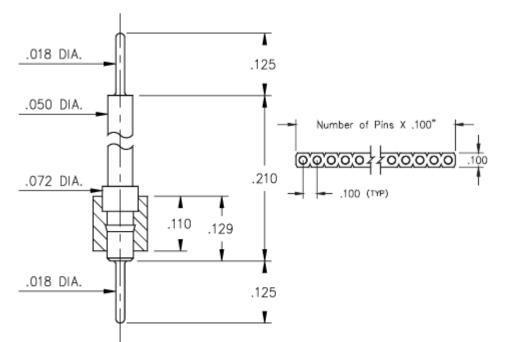
# **DATA SHEET**

#### Product Number: 342-10-101-00-591000



### **Description:**

Interconnect Header .100 Grid; Straight Pin Header .018 Pin Head with Solder Tail Single Row Through Hole

# **Plating Code:**

10

Shell Plating:

10  $\mu^{\text{\tiny{II}}}$  Gold over 100  $\mu^{\text{\tiny{II}}}$  Nickel

#	Mill-Max	RoHS
Of	Part	Compliant
Pins	Number	

1 342-10-101-00-591000



# **LOOSE PIN:**

Pin Used: 4259 (Brass Alloy)

BRASS ALLOY (UNS C36000) per ASTM B 16

#### **Properties of BRASS ALLOY:**

• Chemical composition: Cu 61.5%, Zn 35.4%, Pb 3.1%†

• Hardness as machined: 80-90 Rockwell B

Density: .307 lbs/in3

• Electrical conductivity: 26% IACS\*

Melting point: 900°C/885°C (liquidus/solidus)

†(3 to 4% lead is used to permit "free machining" and is permitted by EC Directive 2002/95Annex 6; so all pin materials are RoHS compliant)

## **INSULATOR INFORMATION:**

<sup>\*</sup>International Annealed Copper Standard, i.e. as a % of pure copper.

## PCT Polyester, (Thermx CG933, black)

High Temperature

## **Properties of PCT Polyester:**

Brand: ThermxGrade: CG-933

• Rated voltage: 100 VRMS/150 VDC

• Insulation resistance: 10,000 Megaohms min.

• Material Heat Deflection Temp (per ASTM D 648): 529°F (276°C) @ 66 psi

• Dielectric strength: 1000 VRMS min. (700 VRMS min. for series 117 Shrink DIP)

Note: Materials above 446°F (230°C) are considered suitable for "eutectic" reflow soldering, above  $500^{\circ}$ F (260°C) for "lead-free" reflow soldering.